

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only).....	-0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only) ..	-0.5V to +7.0V
DC Input Voltage	-0.5V to +7.0V
DC Output Current.....	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range)

Symbol	Parameter	Test Condition ⁽¹⁾		Min.	Typ.	Max.	Units
V _{OH}	Output High Voltage	V _{CC} = 3V, V _{IN} = V _{IH} or V _{IL}	I _{OH} = -8mA	2.4	3.0		V
V _{OL}	Output Low Voltage	V _{CC} = 3V V _{IH} or V _{IL}	I _{OL} = 12mA		0.4	0.5	
V _{IH}	Input High Voltage	Guaranteed Logic HIGH Level (Input pins)		2.0		505	
V _{IL}	Input Low Voltage	Guaranteed Logic LOW Level (Input pins)		-0.5		0.8	
I _{IH}	Input High Current	V _{CC} = 3.6V	V _{IN} = 3.6V			1	μA
I _{IL}	Input Low Current	V _{CC} = 3.6V	V _{IN} = 0V			-1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18mA			-0.7	-1.2	V
I _{OH}	Output HIGH Current	V _{CC} = 3.3V, V _{IN} = V _{IL} or V _{IH} , V _{OUT} = 1.5V ⁽⁵⁾		-25	-45	-80	mA
I _{OL}	Output LOW Current	V _{CC} = 3.3V, V _{IN} = V _{IL} or V _{IH} , V _{OUT} = 1.5V ⁽⁵⁾		25	45	90	
I _{OS}	Short Circuit ⁽⁵⁾ Current	V _{CC} = Max., V _{OUT} = GND ⁽⁵⁾		-50	-100	-180	
V _H	Input Hysteresis				150		mV
R _S	Internal Series Resistor				22		Ω

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 3.3V, +25°C ambient and maximum loading.
- V_{OH} = V_{CC} - 0.6V at rated current.
- This parameter is determined by device characterization but is not production tested.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}	—	0.1	30	μA
ΔI _{CC}	Supply Current per Inputs @ TTL HIGH	V _{CC} = Max.	V _{IN} = V _{CC} – 0.6V ⁽³⁾	—	47	300	
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} = Max., Outputs Open Per Output Toggling 50% Duty Cycle	V _{IN} = V _{CC} V _{IN} = GND	—	0.08	0.16	mA/ MHz

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{CC} = 3.3V, +25°C ambient.
3. Per TTL driven input (V_{IN} = V_{CC} – 0.6V); all other inputs at V_{CC} or GND.
4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
5. Values for these conditions are examples of the I_C formula. These limits are guaranteed but not tested.

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Typ	Max.	Units
C _{IN}	Input Capacitance	V _{IN} = 0V	3.0	4	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V		6	

Notes:

1. This parameter is determined by device characterization but is not production tested.

Maximum Switching Characteristics (Over operating range)

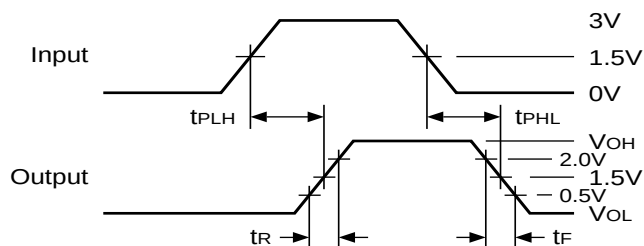
Symbol	Description	Condition	Max.	Units ⁽³⁾
t _{PLH} t _{PHL}	Propagation Delay A to B _N ⁽³⁾	C _L = 15pF	2.5	ns
t _R /t _F	Rise/Fall Time ⁽²⁾	0.8V - 2.0V	1.5	
t _{SK(P)}	Pulse Skew, same package ^(1, 2)	C _L = 15pF	0.35	
t _{SK(O)}	Output Skew, same package ^(1, 2)		0.20	
t _{SK(I)}	Package Skew, different package ^(1, 2)		0.55	
F _{IN}	Input Frequency ^(1, 2)		133	MHz

Notes:

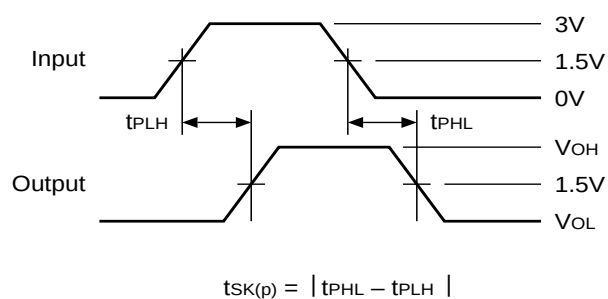
1. Other loading condition is described on page 4, “Test Circuits for All Outputs.”
2. These parameters are guaranteed by design.
3. Minimum propagation delay of 1.5ns is guaranteed by design.

Switching Waveforms

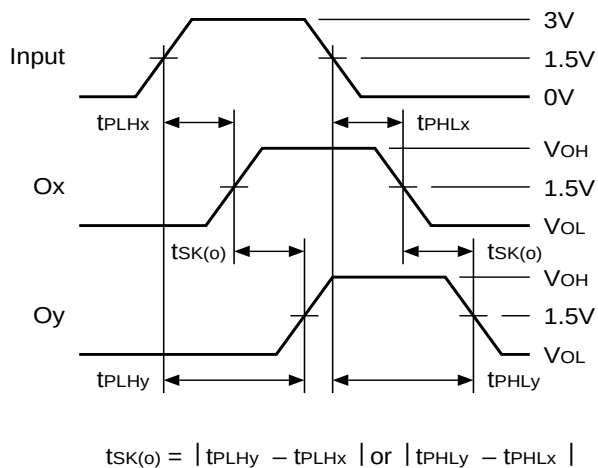
Propagation Delay



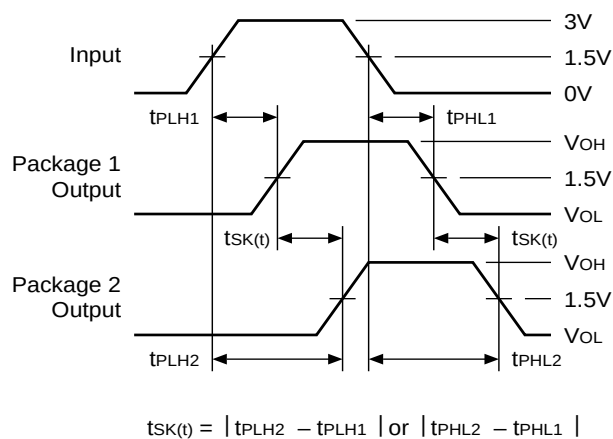
Pulse Skew – $t_{SK(p)}$



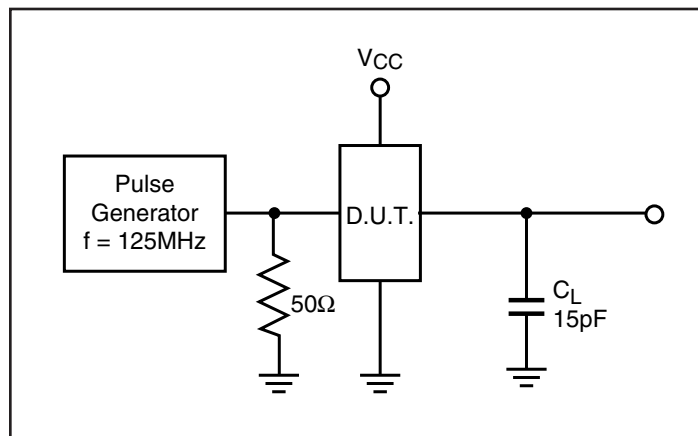
Output Skew – $t_{SK(o)}$

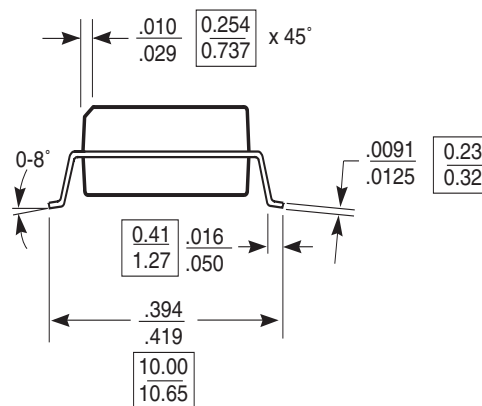
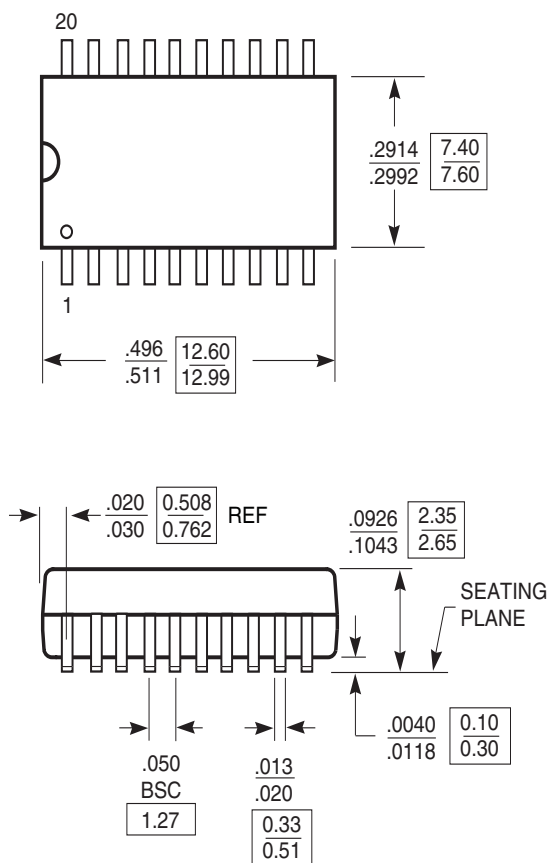


Package Skew – $t_{SK(t)}$



Tests Circuits for All Outputs



Packaging Mechanical: 20-pin SOIC (S)

DOCUMENT CONTROL NO.
PD - 1006
REVISION: D
DATE: 03/09/05

X.XX DENOTES CONTROLLING
X.XX DIMENSIONS IN MILLIMETERS

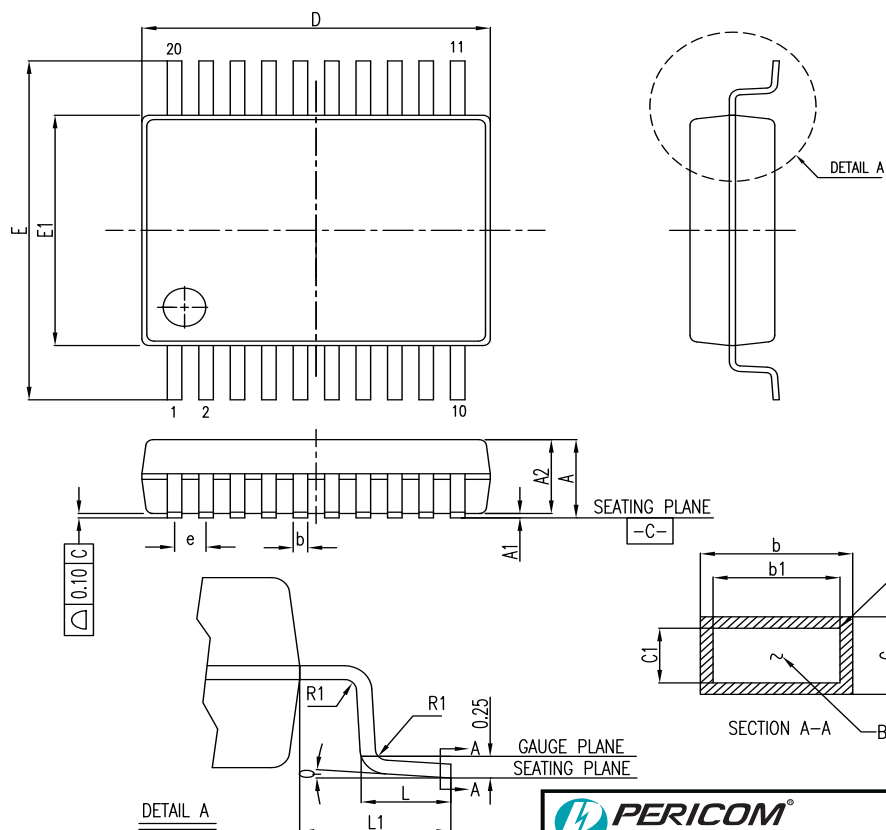
Notes:

- 1) Controlling dimensions in millimeters.
- 2) Ref: JEDEC MS-013D/AC



Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 20-Pin, 300-Mil Wide, SOIC
PACKAGE CODE: S

Packaging Mechanical: 20-pin SSOP (H)


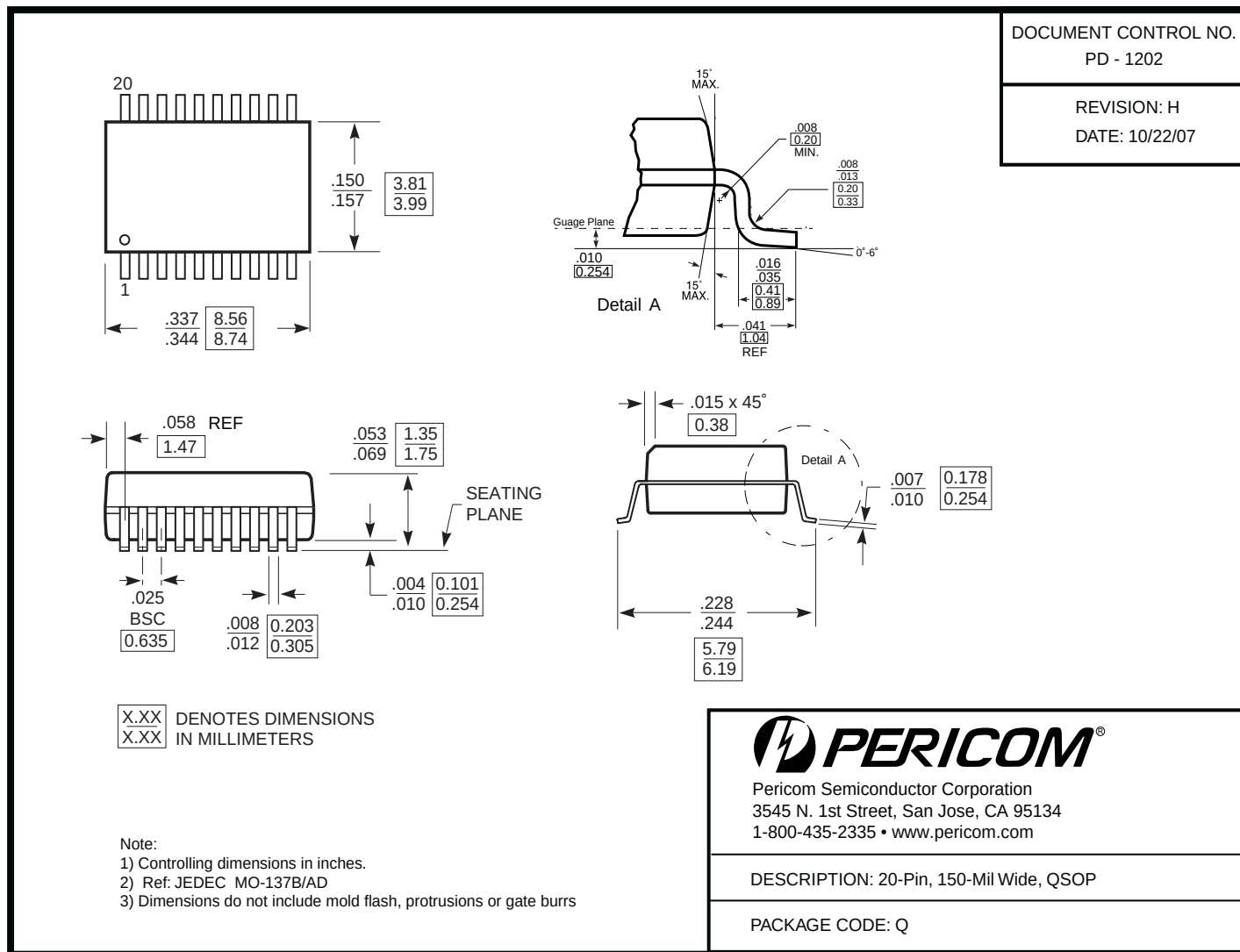
SYMBOL	COMMON DIMENSION MILLIMETERS		
	MIN.	NOM.	MAX.
A	--	--	2.0
A1	0.05	--	--
A2	1.65	1.75	1.85
b	0.22	--	0.38
b1	0.22	0.30	0.33
c	0.09	--	0.25
c1	0.09	0.15	0.21
E	7.40	7.80	8.20
E1	5.00	5.30	5.60
D	6.90	7.20	7.50
e	0.65 BSC		
L	0.55	0.75	0.95
L1	1.25 REF.		
R1	0.09	--	--
θ	0°	4°	8°

NOTE:

1. Controlling dimensions in millimeters
2. Ref.: JEDEC MS-150B/AE
3. Package Outline Exclusive of Mold Flash and Metal Burr


DATE: 04/10/08
DESCRIPTION: 20-Pin, 209-Mil Wide, SSOP
PACKAGE CODE: H20
DOCUMENT CONTROL #: PD-1240
REVISION: E

08-0140

Packaging Mechanical: 20-pin QSOP (Q)

Ordering Information

Ordering Code	Package Code	Package Description
PI49FCT32807HE	H	Pb-free & Green, 20-pin 209-mil SSOP
PI49FCT32807QE	Q	Pb-free & Green, 20-pin 150-mil QSOP
PI49FCT32807SE	S	Pb-free & Green, 20-pin 300-mil SOIC

Notes:

1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
2. Number of Transistors = TBD